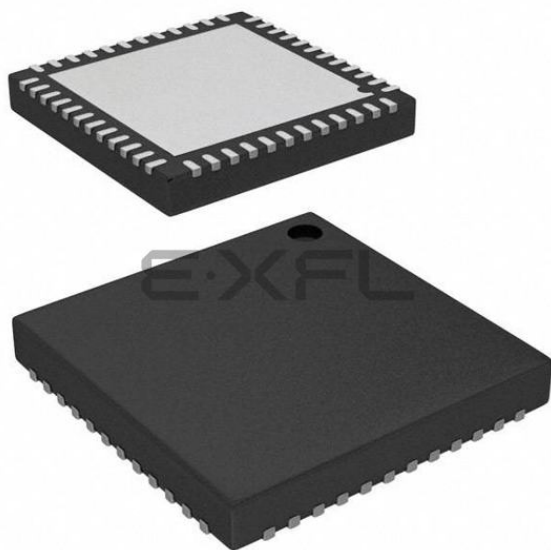




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	M8C
Core Size	8-Bit
Speed	24MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	44
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	A/D 4x14b; D/A 4x9b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-VFQFN Exposed Pad
Supplier Device Package	48-QFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c28623-24ltxit

Figure 4. Analog System Block Diagram for CY8C28x43 Devices

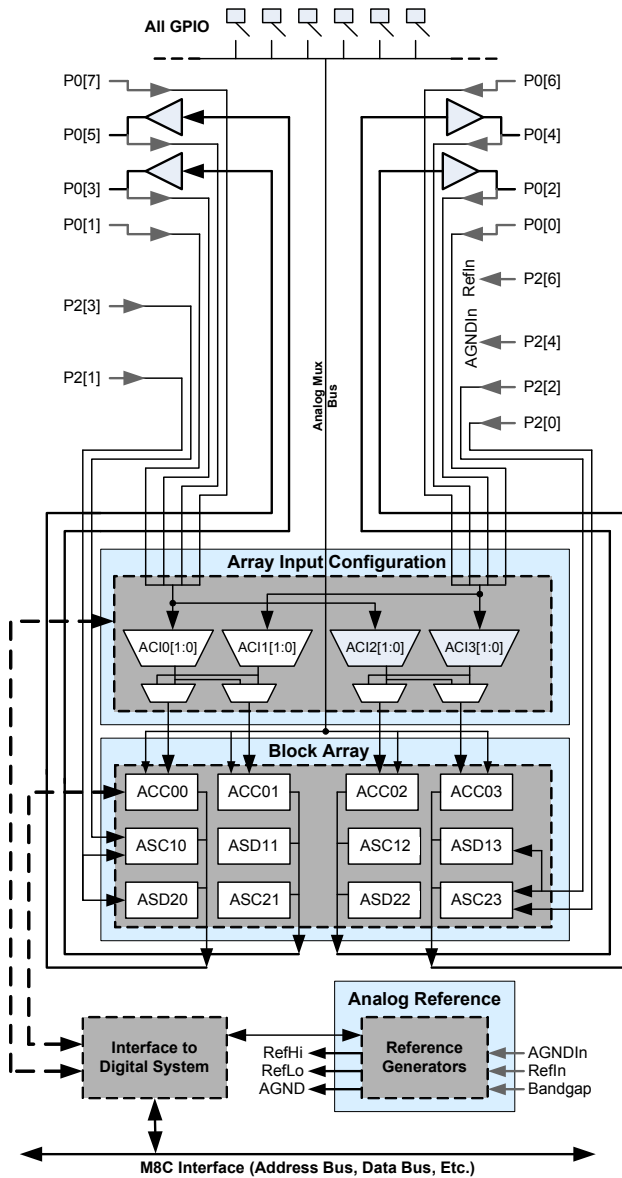
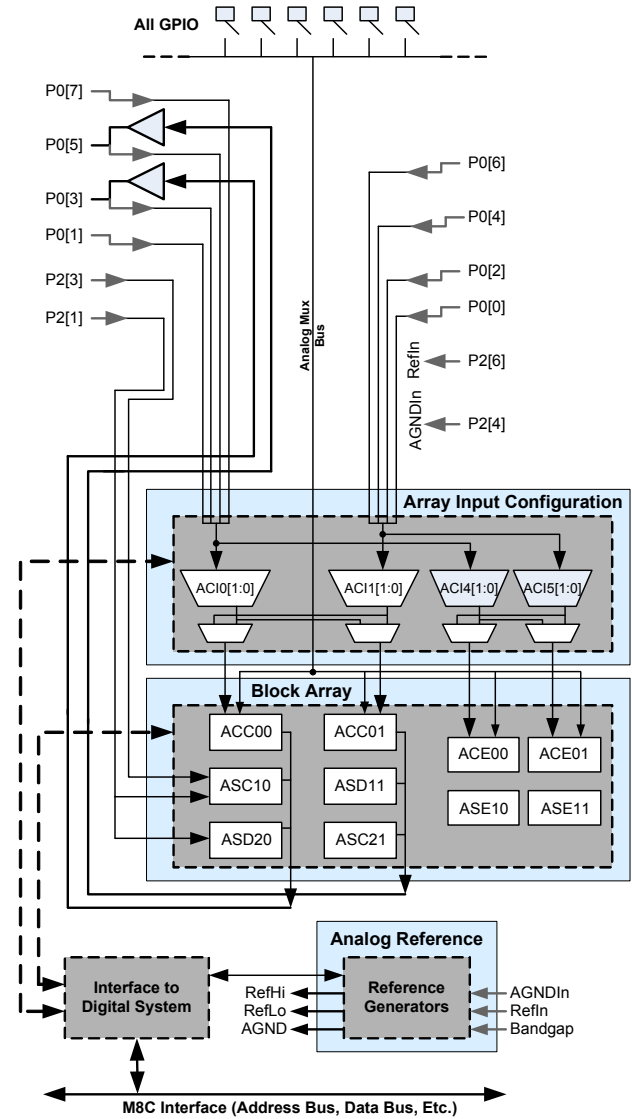


Figure 5. Analog System Block Diagram for CY8C28x33 Devices



System Resources

System Resources, some of which are listed in the previous sections, provide additional capability useful to complete systems. Additional resources include a multiplier, multiple decimators, switch mode pump, low voltage detection, and power on reset. Statements describing the merits of each system resource follow:

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks can be generated using digital PSoC blocks as clock dividers.
- Multiply accumulate (MAC) provides fast 8-bit multiplier with 32-bit accumulate, to assist in general math and digital filters.
- Up to four decimators provide custom hardware filters for digital signal processing applications such as Delta-Sigma ADCs and CapSense capacitive sensor measurement.
- Up to two I²C resources provide 0 to 400 kHz communication over two wires. Slave, master, and multi-master modes are all supported. I²C resources have hardware address detection capability.
- Low Voltage Detection (LVD) interrupts can signal the application of falling voltage levels, while the advanced POR (Power On Reset) circuit eliminates the need for a system supervisor.
- An internal 1.3 V reference provides an absolute reference for the analog system, including ADCs and DACs.
- An integrated switch mode pump (SMP) generates normal operating voltages from a single 1.5 V battery cell, providing a low cost boost converter.

PSoC Device Characteristics

Depending on your PSoC device characteristics, the digital and analog systems can have 16, 8, or 4 digital blocks, and 12, 6, or 4 analog blocks. Table 1 lists the resources available for specific PSoC device groups. The PSoC device covered by this datasheet is highlighted in this table.

Table 1. PSoC Device Characteristics

PSoC Part Number	Digital I/O	Digital Rows	Digital Blocks	Analog Inputs	Analog Outputs	Analog Columns	Analog Blocks	SRAM Size	Flash Size
CY8C29x66	up to 64	4	16	up to 12	4	4	12	2 K	32 K
CY8C28xxx	up to 44	up to 3	up to 12	up to 44	up to 4	up to 6	up to 12 + 4 ^[2]	1 K	16 K
CY8C27x43	up to 44	2	8	up to 12	4	4	12	256	16 K
CY8C24x94	up to 56	1	4	up to 48	2	2	6	1 K	16 K
CY8C24x23A	up to 24	1	4	up to 12	2	2	6	256	4 K
CY8C23x33	up to 26	1	4	up to 12	2	2	4	256	8 K
CY8C22x45	up to 38	2	8	up to 38	0	4	6 ^[2]	1 K	16 K
CY8C21x45	up to 24	1	4	up to 24	0	4	6 ^[2]	512	8 K
CY8C21x34	up to 28	1	4	up to 28	0	2	4 ^[2]	512	8 K
CY8C21x23	up to 16	1	4	up to 8	0	2	4 ^[2]	256	4 K
CY8C20x34	up to 28	0	0	up to 28	0	0	3 ^[2,3]	512	8 K
CY8C20xx6	up to 36	0	0	up to 36	0	0	3 ^[2,3]	up to 2 K	up to 32 K

Notes

2. Limited analog functionality.
3. Two analog blocks and one CapSense®.

Designing with PSoC Designer

The development process for the PSoC device differs from that of a traditional fixed-function microprocessor. The configurable analog and digital hardware blocks give the PSoC architecture a unique flexibility that pays dividends in managing specification change during development and lowering inventory costs. These configurable resources, called PSoC blocks, have the ability to implement a wide variety of user-selectable functions. The PSoC development process is:

1. Select [user modules](#).
2. Configure user modules.
3. Organize and connect.
4. Generate, verify, and debug.

Select User Modules

PSoC Designer provides a library of prebuilt, pretested hardware peripheral components called “user modules.” User modules make selecting and implementing peripheral devices, both analog and digital, simple.

Configure User Modules

Each user module that you select establishes the basic register settings that implement the selected function. They also provide parameters and properties that allow you to tailor their precise configuration to your particular application. For example, a PWM User Module configures one or more digital PSoC blocks, one for each eight bits of resolution. Using these parameters, you can establish the pulse width and duty cycle. Configure the parameters and properties to correspond to your chosen application. Enter values directly or by selecting values from drop-down menus. All of the user modules are documented in datasheets that may be viewed directly in PSoC Designer or on the Cypress website. These [user module datasheets](#) explain the internal operation of the user module and provide performance

specifications. Each datasheet describes the use of each user module parameter, and other information that you may need to successfully implement your design.

Organize and Connect

Build signal chains at the chip level by interconnecting user modules to each other and the I/O pins. Perform the selection, configuration, and routing so that you have complete control over all on-chip resources.

Generate, Verify, and Debug

When you are ready to test the hardware configuration or move on to developing code for the project, perform the “Generate Configuration Files” step. This causes PSoC Designer to generate source code that automatically configures the device to your specification and provides the software for the system. The generated code provides APIs with high-level functions to control and respond to hardware events at run time, and interrupt service routines that you can adapt as needed.

A complete code development environment lets you to develop and customize your applications in C, assembly language, or both.

The last step in the development process takes place inside PSoC Designer's Debugger (accessed by clicking the Connect icon). PSoC Designer downloads the HEX image to the ICE where it runs at full-speed. PSoC Designer debugging capabilities rival those of systems costing many times more. In addition to traditional single-step, run-to-breakpoint, and watch-variable features, the debug interface provides a large trace buffer. It lets you to define complex breakpoint events that include monitoring address and data bus values, memory locations, and external signals.

44-pin Part Pinout

Table 5. 44-pin Part Pinout (TQFP)

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1	I/O	M	P2[5]	
2	I/O	I, M	P2[3]	Direct switched capacitor block input. ^[9]
3	I/O	I, M	P2[1]	Direct switched capacitor block input. ^[9]
4	I/O	M	P4[7]	
5	I/O	M	P4[5]	
6	I/O	M	P4[3]	
7	I/O	M	P4[1]	
8	Output		SMP	Switch Mode Pump (SMP) connection to external components.
9	I/O	M	P3[7]	
10	I/O	M	P3[5]	
11	I/O	M	P3[3]	
12	I/O	M	P3[1]	
13	I/O	M	P1[7]	I2C0 Serial Clock (SCL).
14	I/O	M	P1[5]	I2C0 Serial Data (SDA).
15	I/O	M	P1[3]	
16	I/O	M	P1[1]	Crystal Input (XTALin), I2C0 Serial Clock (SCL), ISSP-SCLK ^[4] .
17	Power		V _{SS}	Ground connection.
18	I/O	M	P1[0]	Crystal Output (XTALout), I2C0 Serial Data (SDA), ISSP-SDATA ^[4] .
19	I/O	M	P1[2]	I2C1 Serial Data (SDA). ^[7]
20	I/O	M	P1[4]	Optional External Clock Input (EXTCLK).
21	I/O	M	P1[6]	I2C1 Serial Clock (SCL). ^[7]
22	I/O	M	P3[0]	I2C1 Serial Data (SDA). ^[7]
23	I/O	M	P3[2]	I2C1 Serial Clock (SCL). ^[7]
24	I/O	M	P3[4]	
25	I/O	M	P3[6]	
26	Input		XRES	Active high external reset with internal pull-down.
27	I/O	M	P4[0]	
28	I/O	M	P4[2]	
29	I/O	M	P4[4]	
30	I/O	M	P4[6]	
31	I/O	I, M	P2[0]	Direct switched capacitor block input. ^[10]
32	I/O	I, M	P2[2]	Direct switched capacitor block input. ^[10]
33	I/O	M	P2[4]	External Analog Ground (AGND).
34	I/O	M	P2[6]	External Voltage Reference (VRef).
35	I/O	I, M, S	P0[0]	Analog column mux and SAR ADC input. ^[5]
36	I/O	I/O, M, S	P0[2]	Analog column mux and SAR ADC input. Analog column output. ^[5, 8]
37	I/O	I/O, M, S	P0[4]	Analog column mux and SAR ADC input. Analog column output. ^[5, 8]
38	I/O	I, M, S	P0[6]	Analog column mux and SAR ADC input. ^[5]
39	Power		V _{DD}	Supply voltage.
40	I/O	I, M, S	P0[7]	Analog column mux and SAR ADC input. ^[5]
41	I/O	I/O, M, S	P0[5]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
42	I/O	I/O, M, S	P0[3]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
43	I/O	I, M, S	P0[1]	Analog column mux and SAR ADC input. ^[5]
44	I/O		P2[7]	

LEGEND: A = Analog, I = Input, O = Output, S = SAR ADC Input, and M = Analog Mux Bus Input.

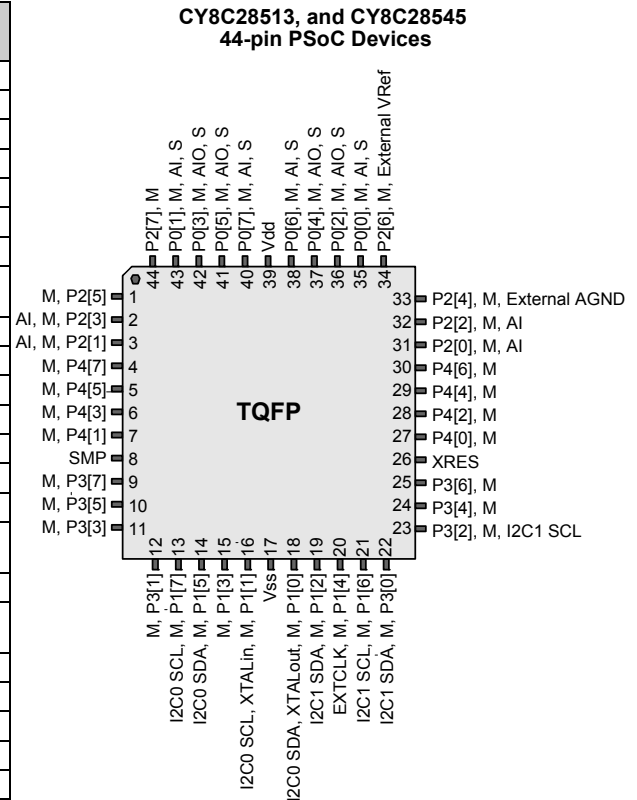


Table 8. CY8C28x03 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW	DBC20DR0	40	#		80		RD12RI	C0	RW
PRT0IE	01	RW	DBC20DR1	41	W		81		RD12SYN	C1	RW
PRT0GS	02	RW	DBC20DR2	42	RW		82		RD12IS	C2	RW
PRT0DM2	03	RW	DBC20CR0	43	#		83		RD12LT0	C3	RW
PRT1DR	04	RW	DBC21DR0	44	#		84		RD12LT1	C4	RW
PRT1IE	05	RW	DBC21DR1	45	W		85		RD12RO0	C5	RW
PRT1GS	06	RW	DBC21DR2	46	RW		86		RD12RO1	C6	RW
PRT1DM2	07	RW	DBC21CR0	47	#		87		RD12DSM	C7	RW
PRT2DR	08	RW	DCC22DR0	48	#		88			C8	
PRT2IE	09	RW	DCC22DR1	49	W		89			C9	
PRT2GS	0A	RW	DCC22DR2	4A	RW		8A			CA	
PRT2DM2	0B	RW	DCC22CR0	4B	#		8B			CB	
PRT3DR	0C	RW	DCC23DR0	4C	#		8C			CC	
PRT3IE	0D	RW	DCC23DR1	4D	W		8D			CD	
PRT3GS	0E	RW	DCC23DR2	4E	RW		8E			CE	
PRT3DM2	0F	RW	DCC23CR0	4F	#		8F			CF	
PRT4DR	10	RW		50			90		CUR_PP	D0	RW
PRT4IE	11	RW		51			91		STK_PP	D1	RW
PRT4GS	12	RW		52			92			D2	
PRT4DM2	13	RW		53			93		IDX_PP	D3	RW
PRT5DR	14	RW		54			94		MVR_PP	D4	RW
PRT5IE	15	RW		55			95		MVW_PP	D5	RW
PRT5GS	16	RW		56			96		I2C0_CFG	D6	RW
PRT5DM2	17	RW		57			97		I2C0_SCR	D7	#
	18			58			98		I2C0_DR	D8	RW
	19			59			99		I2C0_MSCR	D9	#
	1A			5A			9A		INT_CLR0	DA	RW
	1B			5B			9B		INT_CLR1	DB	RW
	1C			5C			9C		INT_CLR2	DC	RW
	1D			5D			9D		INT_CLR3	DD	RW
	1E			5E			9E		INT_MSK3	DE	RW
	1F			5F			9F		INT_MSK2	DF	RW
DBC00DR0	20	#		60			A0		INT_MSK0	E0	RW
DBC00DR1	21	W		61			A1		INT_MSK1	E1	RW
DBC00DR2	22	RW		62			A2		INT_VC	E2	RC
DBC00CR0	23	#		63			A3		RES_WDT	E3	W
DBC01DR0	24	#		64			A4		I2C1_SCR	E4	#
DBC01DR1	25	W		65			A5		I2C1_MSCR	E5	#
DBC01DR2	26	RW		66			A6			E6	
DBC01CR0	27	#	I2C1_DR	67	RW		A7			E7	
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW	SADC_DH	6A	RW	MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#	SADC_DL	6B	RW	MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#		70		RD10RI	B0	RW		F0	
DBC10DR1	31	W		71		RD10SYN	B1	RW		F1	
DBC10DR2	32	RW		72		RD10IS	B2	RW		F2	
DBC10CR0	33	#		73		RD10LT0	B3	RW		F3	
DBC11DR0	34	#		74		RD10LT1	B4	RW		F4	
DBC11DR1	35	W		75		RD10RO0	B5	RW		F5	
DBC11DR2	36	RW		76		RD10RO1	B6	RW		F6	
DBC11CR0	37	#		77		RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#		78		RD11RI	B8	RW		F8	
DCC12DR1	39	W		79		RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW		7A		RD11IS	BA	RW		FA	
DCC12CR0	3B	#		7B		RD11LT0	BB	RW		FB	
DCC13DR0	3C	#		7C		RD11LT1	BC	RW		FC	
DCC13DR1	3D	W		7D		RD11RO0	BD	RW		FD	
DCC13DR2	3E	RW		7E		RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#		7F		RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 10. CY8C28x13 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW	DBC20DR0	40	#		80		RD12RI	C0	RW
PRT0IE	01	RW	DBC20DR1	41	W		81		RD12SYN	C1	RW
PRT0GS	02	RW	DBC20DR2	42	RW		82		RD12IS	C2	RW
PRT0DM2	03	RW	DBC20CR0	43	#		83		RD12LT0	C3	RW
PRT1DR	04	RW	DBC21DR0	44	#		84		RD12LT1	C4	RW
PRT1IE	05	RW	DBC21DR1	45	W		85		RD12RO0	C5	RW
PRT1GS	06	RW	DBC21DR2	46	RW		86		RD12RO1	C6	RW
PRT1DM2	07	RW	DBC21CR0	47	#		87		RD12DSM	C7	RW
PRT2DR	08	RW	DCC22DR0	48	#		88			C8	
PRT2IE	09	RW	DCC22DR1	49	W		89			C9	
PRT2GS	0A	RW	DCC22DR2	4A	RW		8A			CA	
PRT2DM2	0B	RW	DCC22CR0	4B	#		8B			CB	
PRT3DR	0C	RW	DCC23DR0	4C	#		8C			CC	
PRT3IE	0D	RW	DCC23DR1	4D	W		8D			CD	
PRT3GS	0E	RW	DCC23DR2	4E	RW		8E			CE	
PRT3DM2	0F	RW	DCC23CR0	4F	#		8F			CF	
PRT4DR	10	RW		50			90		CUR_PP	D0	RW
PRT4IE	11	RW		51			91		STK_PP	D1	RW
PRT4GS	12	RW		52			92			D2	
PRT4DM2	13	RW		53			93		IDX_PP	D3	RW
PRT5DR	14	RW		54			94		MVR_PP	D4	RW
PRT5IE	15	RW		55			95		MVW_PP	D5	RW
PRT5GS	16	RW		56			96		I2C0_CFG	D6	RW
PRT5DM2	17	RW		57			97		I2C0_SCR	D7	#
	18			58			98		I2C0_DR	D8	RW
	19			59			99		I2C0_MSCR	D9	#
	1A			5A			9A		INT_CLR0	DA	RW
	1B			5B			9B		INT_CLR1	DB	RW
	1C			5C			9C		INT_CLR2	DC	RW
	1D			5D			9D		INT_CLR3	DD	RW
	1E			5E			9E		INT_MSK3	DE	RW
	1F			5F			9F		INT_MSK2	DF	RW
DBC00DR0	20	#		60		DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW		62		DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#		63		DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#		64			A4			E4	
DBC01DR1	25	W		65			A5			E5	
DBC01DR2	26	RW		66			A6		DEC_CR0*	E6	RW
DBC01CR0	27	#		67			A7		DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW	SADC_DH	6A	RW	MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#	SADC_DL	6B	RW	MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#		70		RD10RI	B0	RW		F0	
DBC10DR1	31	W		71		RD10SYN	B1	RW		F1	
DBC10DR2	32	RW		72		RD10IS	B2	RW		F2	
DBC10CR0	33	#		73		RD10LT0	B3	RW		F3	
DBC11DR0	34	#		74		RD10LT1	B4	RW		F4	
DBC11DR1	35	W		75		RD10RO0	B5	RW		F5	
DBC11DR2	36	RW		76		RD10RO1	B6	RW		F6	
DBC11CR0	37	#		77		RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#		78		RD11RI	B8	RW		F8	
DCC12DR1	39	W		79		RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW		7A		RD11IS	BA	RW		FA	
DCC12CR0	3B	#		7B		RD11LT0	BB	RW		FB	
DCC13DR0	3C	#		7C		RD11LT1	BC	RW	DAC1_D	FC	RW
DCC13DR1	3D	W		7D		RD11RO0	BD	RW	DAC0_D	FD	RW
DCC13DR2	3E	RW		7E		RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#		7F		RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 11. CY8C28x13 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80		RD12RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RD12SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RD12IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RD12LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84		RD12LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RD12RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RD12RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RD12DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88			C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C	RW		CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56			96			D6	
PRT5IC1	17	RW		57			97			D7	
	18			58			98		MUX_CR0	D8	RW
	19			59			99		MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D			9D		OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW		60		GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW		61		GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW		62		GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW		63		GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW		64		RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW		65		RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW		66		RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW		67		RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW		68		SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW		69		SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW		6B		SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RD10RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RD10SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RD10LT0	B3	RW		F3	
DBC11FN	34	RW		74	RW	RD10LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RD10RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RD10RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RD11RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GL_EN	79	RW	RD11SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RD11IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RD11LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RD11LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RD11RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 12. CY8C28x23 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW	DBC20DR0	40	#	ASC10CR0	80	RW	RD12RI	C0	RW
PRT0IE	01	RW	DBC20DR1	41	W	ASC10CR1	81	RW	RD12SYN	C1	RW
PRT0GS	02	RW	DBC20DR2	42	RW	ASC10CR2	82	RW	RD12IS	C2	RW
PRT0DM2	03	RW	DBC20CR0	43	#	ASC10CR3	83	RW	RD12LT0	C3	RW
PRT1DR	04	RW	DBC21DR0	44	#	ASD11CR0	84	RW	RD12LT1	C4	RW
PRT1IE	05	RW	DBC21DR1	45	W	ASD11CR1	85	RW	RD12RO0	C5	RW
PRT1GS	06	RW	DBC21DR2	46	RW	ASD11CR2	86	RW	RD12RO1	C6	RW
PRT1DM2	07	RW	DBC21CR0	47	#	ASD11CR3	87	RW	RD12DSM	C7	RW
PRT2DR	08	RW	DCC22DR0	48	#		88			C8	
PRT2IE	09	RW	DCC22DR1	49	W		89			C9	
PRT2GS	0A	RW	DCC22DR2	4A	RW		8A			CA	
PRT2DM2	0B	RW	DCC22CR0	4B	#		8B			CB	
PRT3DR	0C	RW	DCC23DR0	4C	#		8C			CC	
PRT3IE	0D	RW	DCC23DR1	4D	W		8D			CD	
PRT3GS	0E	RW	DCC23DR2	4E	RW		8E			CE	
PRT3DM2	0F	RW	DCC23CR0	4F	#		8F			CF	
PRT4DR	10	RW		50		ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW		51		ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW		52		ASD20CR2	92	RW		D2	
PRT4DM2	13	RW		53		ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW		54		ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW		55		ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW		56		ASC21CR2	96	RW	I2C0_CFG	D6	RW
PRT5DM2	17	RW		57		ASC21CR3	97	RW	I2C0_SCR	D7	#
	18			58			98		I2C0_DR	D8	RW
	19			59			99		I2C0_MSCR	D9	#
	1A			5A			9A		INT_CLR0	DA	RW
	1B			5B			9B		INT_CLR1	DB	RW
	1C			5C			9C		INT_CLR2	DC	RW
	1D			5D			9D		INT_CLR3	DD	RW
	1E			5E			9E		INT_MSK3	DE	RW
	1F			5F			9F		INT_MSK2	DF	RW
DBC00DR0	20	#	AMX_IN	60	RW	DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW	CLK_CR3	62	RW	DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#	ARF_CR	63	RW	DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#	CMP_CR0	64	#		A4		I2C1_SCR	E4	#
DBC01DR1	25	W	ASY_CR	65	#		A5		I2C1_MSCR	E5	#
DBC01DR2	26	RW	CMP_CR1	66	RW		A6		DEC_CR0*	E6	RW
DBC01CR0	27	#	I2C1_DR	67	RW		A7		DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW		6A		MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#		6B		MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#	ACB00CR3	70	RW	RD10RI	B0	RW		F0	
DBC10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBC10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBC11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBC11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBC11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBC11CR0	37	#	ACB01CR2	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#		78		RD11RI	B8	RW		F8	
DCC12DR1	39	W		79		RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW		7A		RD11IS	BA	RW		FA	
DCC12CR0	3B	#		7B		RD11LT0	BB	RW		FB	
DCC13DR0	3C	#		7C		RD11LT1	BC	RW		FC	
DCC13DR1	3D	W		7D		RD11RO0	BD	RW		FD	
DCC13DR2	3E	RW		7E		RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#		7F		RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 19. CY8C28x45 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80	RW	RD12RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RD12SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RD12IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RD12LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84	RW	RD12LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RD12RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RD12RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RD12DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88	RW		C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C	RW		CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56		DEC_CR4	96	RW	DEC2_CR	D6	RW
PRT5IC1	17	RW		57			97		DEC3_CR	D7	RW
	18			58			98		MUX_CR0	D8	RW
	19			59		DEC2_CR0	99	RW	MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D		DEC3_CR0	9D	RW	OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW	CMP_GO_EN1	65	RW	RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW	ALT_CR1	68	RW	SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW	SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW	I2C1_CFG	6B	RW	SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW	I2C1_ADDR	AE	RW		EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RD10RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RD10SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RD10LT0	B3	RW		F3	
DBC11FN	34	RW		74		RD10LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RD10RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RD10RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RD11RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RD11SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RD11IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RD11LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RD11LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RD11RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 20. CY8C28x52 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW		40		ASC10CR0	80	RW		C0	
PRT0IE	01	RW		41		ASC10CR1	81	RW		C1	
PRT0GS	02	RW		42		ASC10CR2	82	RW		C2	
PRT0DM2	03	RW		43		ASC10CR3	83	RW		C3	
PRT1DR	04	RW		44		ASD11CR0	84	RW		C4	
PRT1IE	05	RW		45		ASD11CR1	85	RW		C5	
PRT1GS	06	RW		46		ASD11CR2	86	RW		C6	
PRT1DM2	07	RW		47		ASD11CR3	87	RW		C7	
PRT2DR	08	RW		48		ASC12CR0	88	RW		C8	
PRT2IE	09	RW		49		ASC12CR1	89	RW		C9	
PRT2GS	0A	RW		4A		ASC12CR2	8A	RW		CA	
PRT2DM2	0B	RW		4B		ASC12CR3	8B	RW		CB	
PRT3DR	0C	RW		4C		ASD13CR0	8C	RW		CC	
PRT3IE	0D	RW		4D		ASD13CR1	8D	RW		CD	
PRT3GS	0E	RW		4E		ASD13CR2	8E	RW		CE	
PRT3DM2	0F	RW		4F		ASD13CR3	8F	RW		CF	
PRT4DR	10	RW		50		ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW		51		ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW		52		ASD20CR2	92	RW		D2	
PRT4DM2	13	RW		53		ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW		54		ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW		55		ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW		56		ASC21CR2	96	RW	I2C0_CFG	D6	RW
PRT5DM2	17	RW		57		ASC21CR3	97	RW	I2C0_SCR	D7	#
	18			58		ASD22CR0	98	RW	I2C0_DR	D8	RW
	19			59		ASD22CR1	99	RW	I2C0_MSCR	D9	#
	1A			5A		ASD22CR2	9A	RW	INT_CLR0	DA	RW
	1B			5B		ASD22CR3	9B	RW	INT_CLR1	DB	RW
	1C			5C		ASC23CR0	9C	RW	INT_CLR2	DC	RW
	1D			5D		ASC23CR1	9D	RW	INT_CLR3	DD	RW
	1E			5E		ASC23CR2	9E	RW	INT_MSK3	DE	RW
	1F			5F		ASC23CR3	9F	RW	INT_MSK2	DF	RW
DBC00DR0	20	#	AMX_IN	60	RW	DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW	CLK_CR3	62	RW	DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#	ARF_CR	63	RW	DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#	CMP_CR0	64	#	DEC2_DH	A4	RC		E4	
DBC01DR1	25	W	ASY_CR	65	#	DEC2_DL	A5	RC		E5	
DBC01DR2	26	RW	CMP_CR1	66	RW	DEC3_DH	A6	RC	DEC_CR0*	E6	RW
DBC01CR0	27	#		67		DEC3_DL	A7	RC	DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW		6A		MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#		6B		MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#	ACB00CR3	70	RW	RD10RI	B0	RW		F0	
DBC10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBC10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBC11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBC11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBC11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBC11CR0	37	#	ACB01CR2	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#	ACB02CR3	78	RW	RD11RI	B8	RW		F8	
DCC12DR1	39	W	ACB02CR0	79	RW	RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW	ACB02CR1	7A	RW	RD11IS	BA	RW		FA	
DCC12CR0	3B	#	ACB02CR2	7B	RW	RD11LT0	BB	RW		FB	
DCC13DR0	3C	#	ACB03CR3	7C	RW	RD11LT1	BC	RW	DAC1_D	FC	RW
DCC13DR1	3D	W	ACB03CR0	7D	RW	RD11RO0	BD	RW	DAC0_D	FD	RW
DCC13DR2	3E	RW	ACB03CR1	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#	ACB03CR2	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Electrical Specifications

This section presents the DC and AC electrical specifications of the CY8C28xxx PSoC devices. For the most up to date electrical specifications, confirm that you have the most recent datasheet by going to the web at <http://www.cypress.com>.

Specifications are valid for $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ and $T_J \leq 100^{\circ}\text{C}$, except where noted. Specifications for devices running at greater than 12 MHz are valid for $-40^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$ and $T_J \leq 82^{\circ}\text{C}$.

Figure 8. Voltage versus CPU Frequency

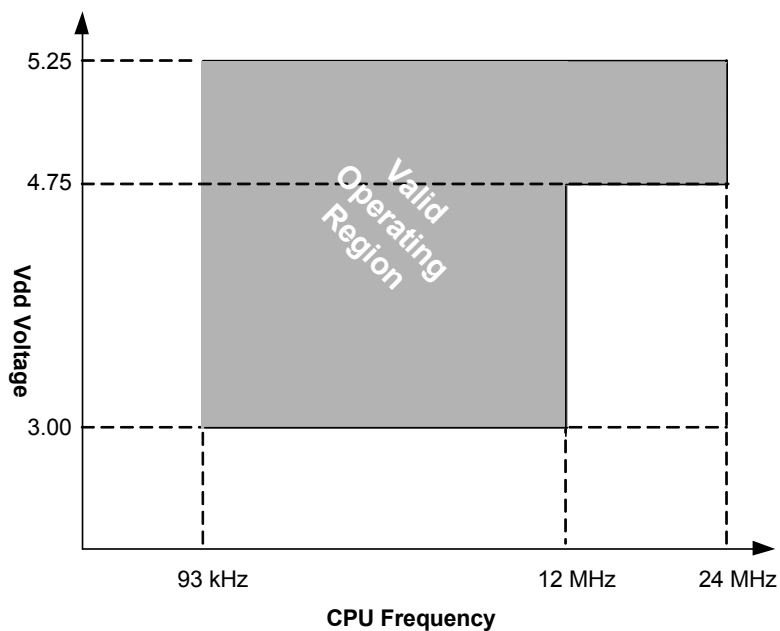


Table 32. 3.3 V DC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
C_L	Load Capacitance	–	–	200	pF	This specification applies to the external circuit that is being driven by the analog output buffer.
V_{OSOB}	Input Offset Voltage (Absolute Value)	–	3	12	mV	
TCV_{OSOB}	Average Input Offset Voltage Drift	–	+6	20	$\mu V/^{\circ}C$	
V_{CMOB}	Common-Mode Input Voltage Range	0.5	–	$V_{DD} - 1.0$	V	
R_{OUTOB}	Output Resistance Power = Low Power = High	– –	1 1	– –	Ω Ω	
$V_{OHIGHOB}$	High Output Voltage Swing (Load = 1 k Ω to $V_{DD}/2$) Power = Low Power = High	$0.5 \times V_{DD} + 1.0$ $0.5 \times V_{DD} + 1.0$	– –	– –	V V	
V_{OLOWOB}	Low Output Voltage Swing (Load = 1 k Ω to $V_{DD}/2$) Power = Low Power = High	– –	– –	$0.5 \times V_{DD} - 1.0$ $0.5 \times V_{DD} - 1.0$	V V	
I_{SOB}	Supply current including bias cell (No Load) Power = Low Power = High	– –	0.8 2.0	2.0 4.3	mA mA	
$PSRR_{OB}$	Supply voltage rejection ratio	47	64	–	dB	$(0.5 \times V_{DD} - 1.0) \leq V_{OUT} \leq (0.5 \times V_{DD} + 0.9)$.

Table 34. 5-V DC Analog Reference Specifications (continued)

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b001	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	P2[4]+P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.055	P2[4] + P2[6] – 0.019	P2[4] + P2[6] + 0.019	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4]–P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.030	P2[4] – P2[6] + 0.005	P2[4] – P2[6] + 0.035	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	P2[4]+P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.05	P2[4] + P2[6] – 0.015	P2[4] + P2[6] + 0.021	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4]–P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.033	P2[4] – P2[6] + 0.001	P2[4] – P2[6] + 0.031	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	P2[4]+P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.048	P2[4] + P2[6] – 0.013	P2[4] + P2[6] + 0.022	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4]–P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.034	P2[4] – P2[6] – 0.001	P2[4] – P2[6] + 0.031	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	P2[4]+P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.047	P2[4] + P2[6] – 0.012	P2[4] + P2[6] + 0.023	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4]–P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.036	P2[4] – P2[6] – 0.002	P2[4] – P2[6] + 0.030	V
0b010	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	V _{DD}	V _{DD} – 0.028	V _{DD} – 0.010	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.014	V _{DD} /2 – 0.002	V _{DD} /2 + 0.012	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.004	V _{SS} + 0.008	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	V _{DD}	V _{DD} – 0.021	V _{DD} – 0.007	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.014	V _{DD} /2 – 0.001	V _{DD} /2 + 0.012	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.002	V _{SS} + 0.005	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	V _{DD}	V _{DD} – 0.019	V _{DD} – 0.006	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.014	V _{DD} /2 – 0.001	V _{DD} /2 + 0.012	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.002	V _{SS} + 0.004	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	V _{DD}	V _{DD} – 0.017	V _{DD} – 0.005	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.014	V _{DD} /2 – 0.001	V _{DD} /2 + 0.013	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.001	V _{SS} + 0.003	V

Table 34. 5-V DC Analog Reference Specifications (continued)

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b101	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.218	P2[4] + 1.283	P2[4] + 1.344	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.329	P2[4] – 1.297	P2[4] – 1.265	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.225	P2[4] + 1.287	P2[4] + 1.346	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.330	P2[4] – 1.301	P2[4] – 1.271	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.226	P2[4] + 1.288	P2[4] + 1.346	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.330	P2[4] – 1.302	P2[4] – 1.272	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.227	P2[4] + 1.289	P2[4] + 1.347	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.331	P2[4] – 1.303	P2[4] – 1.273	V
0b110	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.506	2.597	2.674	V
		V _{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.006	V _{SS} + 0.014	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.508	2.595	2.675	V
		V _{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.003	V _{SS} + 0.008	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.508	2.595	2.676	V
		V _{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.002	V _{SS} + 0.005	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.508	2.596	2.677	V
		V _{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.001	V _{SS} + 0.003	V

Table 35. 3.3-V DC Analog Reference Specifications (continued)

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b101	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.226	P2[4] + 1.286	P2[4] + 1.343	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.323	P2[4] – 1.293	P2[4] – 1.262	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.232	P2[4] + 1.29	P2[4] + 1.344	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.296	P2[4] – 1.267	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.233	P2[4] + 1.291	P2[4] + 1.345	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.298	P2[4] – 1.269	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.234	P2[4] + 1.292	P2[4] + 1.345	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.299	P2[4] – 1.270	V
0b110	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.504	2.595	2.672	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.006	V _{SS} + 0.013	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.506	2.593	2.674	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.003	V _{SS} + 0.008	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.506	2.594	2.675	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.335	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.002	V _{SS} + 0.007	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.507	2.595	2.675	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.335	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.001	V _{SS} + 0.005	V
0b111	All power settings. Not allowed for 3.3 V.	–	–	–	–	–	–	–

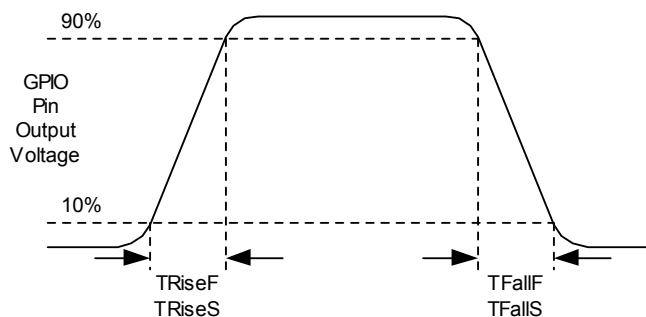
AC GPIO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 44. AC GPIO Specifications

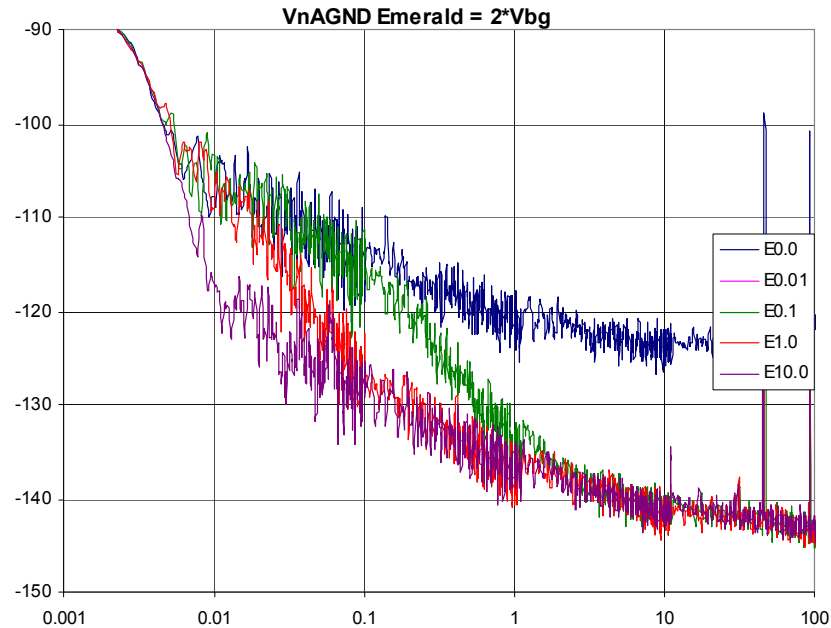
Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO Operating Frequency	0	—	12.3	MHz	Normal Strong Mode
t_{RiseF}	Rise Time, Normal Strong Mode, Load = 50 pF	3	—	18	ns	$V_{\text{DD}} = 4.5$ to 5.25 V, 10% – 90%
t_{FallF}	Fall Time, Normal Strong Mode, Load = 50 pF	2	—	18	ns	$V_{\text{DD}} = 4.5$ to 5.25 V, 10% – 90%
t_{RiseS}	Rise Time, Slow Strong Mode, Load = 50 pF	10	27	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% – 90%
t_{FallS}	Fall Time, Slow Strong Mode, Load = 50 pF	10	22	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% – 90%

Figure 13. GPIO Timing Diagram



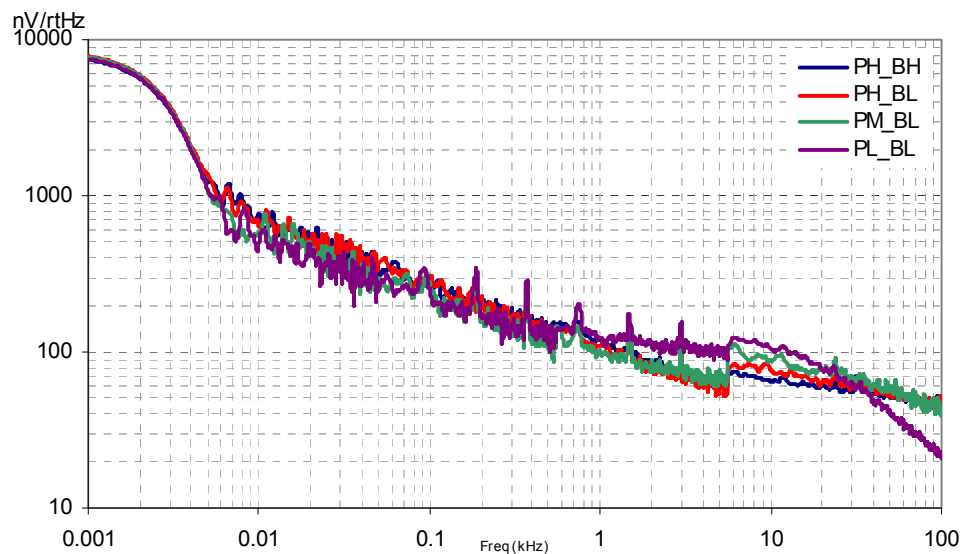
When bypassed by a capacitor on P2[4], the noise of the analog ground signal distributed to each block is reduced by a factor of up to 5 (14 dB). This is at frequencies above the corner frequency defined by the on-chip 8.1k resistance and the external capacitor.

Figure 14. Typical AGND Noise with P2[4] Bypass



At low frequencies, the opamp noise is proportional to $1/f$, power independent, and determined by device geometry. At high frequencies, increased power level reduces the noise spectrum level.

Figure 15. Typical Opamp Noise



Glossary *(continued)*

microcontroller	An integrated circuit chip that is designed primarily for control systems and products. In addition to a CPU, a microcontroller typically includes memory, timing circuits, and IO circuitry. The reason for this is to permit the realization of a controller with a minimal quantity of chips, thus achieving maximal possible miniaturization. This in turn, reduces the volume and the cost of the controller. The microcontroller is normally not used for general-purpose computation as is a microprocessor.
mixed-signal	The reference to a circuit containing both analog and digital techniques and components.
modulator	A device that imposes a signal on a carrier.
noise	1. A disturbance that affects a signal and that may distort the information carried by the signal. 2. The random variations of one or more characteristics of any entity such as voltage, current, or data.
oscillator	A circuit that may be crystal controlled and is used to generate a clock frequency.
parity	A technique for testing transmitting data. Typically, a binary digit is added to the data to make the sum of all the digits of the binary data either always even (even parity) or always odd (odd parity).
phase-locked loop (PLL)	An electronic circuit that controls an oscillator so that it maintains a constant phase angle relative to a reference signal.
pinouts	The pin number assignment: the relation between the logical inputs and outputs of the PSoC device and their physical counterparts in the printed circuit board (PCB) package. Pinouts involve pin numbers as a link between schematic and PCB design (both being computer generated files) and may also involve pin names.
port	A group of pins, usually eight.
power on reset (POR)	A circuit that forces the PSoC device to reset when the voltage is lower than a pre-set level. This is one type of hardware reset.
PSoC®	Cypress Semiconductor's PSoC® is a registered trademark and Programmable System-on-Chip™ is a trademark of Cypress.
PSoC Designer™	The software for Cypress' Programmable System-on-Chip technology.
pulse width modulator (PWM)	An output in the form of duty cycle which varies as a function of the applied measurand
RAM	An acronym for random access memory. A data-storage device from which data can be read out and new data can be written in.
register	A storage device with a specific capacity, such as a bit or byte.
reset	A means of bringing a system back to a know state. See hardware reset and software reset.
ROM	An acronym for read only memory. A data-storage device from which data can be read out, but new data cannot be written in.
serial	1. Pertaining to a process in which all events occur one after the other. 2. Pertaining to the sequential or consecutive occurrence of two or more related activities in a single device or channel.
settling time	The time it takes for an output signal or value to stabilize after the input has changed from one value to another.

1. 10-bit SAR ADC does not meet DNL/INL specification.

■ Problem Definition

The 10-bit hardware SAR ADC does not meet datasheet accuracy specifications for DNL and INL under some conditions.

■ Parameters Affected

INLSAR10: Integral nonlinearity

DNLSAR10: Differential nonlinearity

■ Trigger Condition(S)

The SAR ADC DNL has been measured greater than 2 LSB over temperature in all cases, as compared to the datasheet specification of 1.5 LSB.

When using the VPWR (Vdd) reference configuration, the SAR ADC DNL has been measured over temperature at 2 LSB for a supply voltage of 3.3 V. With a supply voltage of 5.5 V, the DNL has been measured greater than 3.5 LSB.

■ Scope of Impact

Inaccurate converted data.

■ Workaround

- Use an alternate ADC implementation (DelSig, ADCINC) available in CY8C28xxx devices.
- Avoid CPU operations that change the address and data buses while A-D conversion is running with internal Vpwr (Vdd) as Vref.
- Use un-buffered RefHi as ADC Vref. This may have a negative effect on the analog blocks in the analog array due to the noise introduced on RefHi reference.

■ Fix Status

Silicon fix is not planned. The workaround mentioned above should be used.

2. Wrong data read from IDAC_CRx and DACx_D registers.

■ Problem Definition

The CPU may read an incorrect value of bits 0, 3, 5, or 7 from the following registers:

- IDAC_CR0
- IDAC_CR1
- DAC0_D
- DAC1_D

■ Parameters Affected

F_{CPU1} and F_{CPU2} from the device data sheet.

■ Trigger Condition(S)

When CPU Clock is set at its highest frequency setting (24 MHz nominal).

■ Scope of Impact

Incorrect data read from affected registers.

■ Workaround

Temporarily slow down CPU Clock frequency to 12 MHz nominal (or lower) when affected registers are read.

Document History Page *(continued)*

Document Title: CY8C28243/CY8C28403/CY8C28413/CY8C28433/CY8C28445/CY8C28452/CY8C28513/CY8C28545/ CY8C28623/CY8C28643/CY8C28645, PSoC® Programmable System-on-Chip™ Document Number: 001-48111				
Revision	ECN	Origin of Change	Submission Date	Description of Change
*L	3993399	GVH	05/08/2013	Updated Reference Documents (Removed 001-17397 spec, 001-14503 spec related information). Added Errata .
*M	4138595	GVH	09/27/2013	Updated to new template. Completing Sunset Review.
*N	4476160	ASRI / SEG	09/04/2014	Replaced references of "Application Notes for Surface Mount Assembly of Amkor's MicroLeadFrame (MLF) Packages" with "Design Guidelines for Cypress Quad Flat No Extended Lead (QFN) Packaged Devices – AN72845" in all instances across the document. Added More Information . Added PSoC Designer . Updated PSoC Functional Overview : Updated PSoC Device Characteristics : Updated Table 2 : Added a column "Analog Mux Buses" at the end. Removed "Getting Started". Updated Electrical Specifications : Updated DC Electrical Characteristics : Updated DC I2C Specifications : Updated Table 42 : Added V_{OL12C} parameter and its details. Updated Packaging Information : spec 51-85064 – Changed revision from *E to *F. Completing Sunset Review.
*O	4914758	ASRI	09/10/2015	Updated Document Title to read as "CY8C28243/CY8C28403/CY8C28413/CY8C28433/CY8C28445/CY8C28452/CY8C28513/CY8C28545/CY8C28623/CY8C28643/CY8C28645, PSoC® Programmable System-on-Chip™". Removed CY8C28533 related information in all instances across the document. Updated Electrical Specifications : Updated DC Electrical Characteristics : Updated DC SAR10 ADC Specifications : Updated Table 38 : Updated details in "Description" column of DNL_{SAR10} parameter. Updated Packaging Information : Updated Packaging Dimensions : spec 51-85077 – Changed revision from *E to *F. spec 51-85079 – Changed revision from *E to *F. spec 001-45616 – Changed revision from *D to *E. Updated Development Tool Selection : Updated Accessories (Emulation and Programming) : Updated Table 60 : Updated details in "Part #" column corresponding to 44-pin TQFP package. Updated Ordering Information : Updated part numbers. Updated Errata : Updated Part Numbers Affected : Updated table. Updated Errata Summary : Updated table and also details below the table. Updated to new template. Completing Sunset Review.